

UC2856Q

SGLS265A -NOVEMBER 2004-REVISED MAY 2011

IMPROVED CURRENT MODE PWM CONTROLLER

Check for Samples: UC2856Q

FEATURES

- Pin-for-Pin Compatible With the UC2846
- 65-ns Typical Delay From Shutdown to Outputs and 50-ns Typical Delay From Sync to Outputs
- Improved Current Sense Amplifier With Reduced Noise Sensitivity
- Differential Current Sense With 3-V Common Mode Range
- Trimmed Oscillator Discharge Current for Accurate Deadband Control
- Accurate 1-V Shutdown Threshold
- High Current Dual Totem Pole Outputs (1.5-A peak)
- TTL Compatible Oscillator SYNC Pin Thresholds
- 4-kV ESD Protection

DESCRIPTION

The UC2856 is a high performance version of the popular UC2846 series of current mode controllers, and is intended for both design upgrades and new applications where speed and accuracy are important. All input to output delays have been minimized, and the current sense output is slew rate limited to reduce noise sensitivity. Fast 1.5-A peak output stages have been added to allow rapid switching of power FETs.

A low impedance TTL compatible sync output has been implemented with a 3-state function when used as a sync input.

Internal chip grounding has been improved to minimize internal *noise* caused when driving large capacitive loads. This, in conjunction with the improved differential current sense amplifier, results in enhanced noise immunity.

Other features include a trimmed oscillator current (8%) for accurate frequency and dead time control; a 1 V, 5% shutdown threshold; and 4 kV minimum ESD protection on all pins.

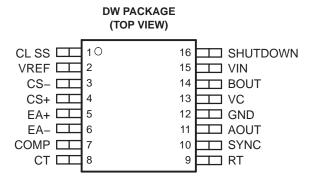
| T _A | PAG | CKAGE | ORDERABLE PART NUMBER | TOP-SIDE MARKING | | | | | | |
|----------------|--------|---------------|--------------------------|---------------------|--|--|--|--|--|--|
| –40°C to 125°C | SOP-DW | Tape and reel | UC2856QDWR | UC2856Q | | | | | | |

ORDERING INFORMATION⁽¹⁾

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



P0008-01

UC2856Q

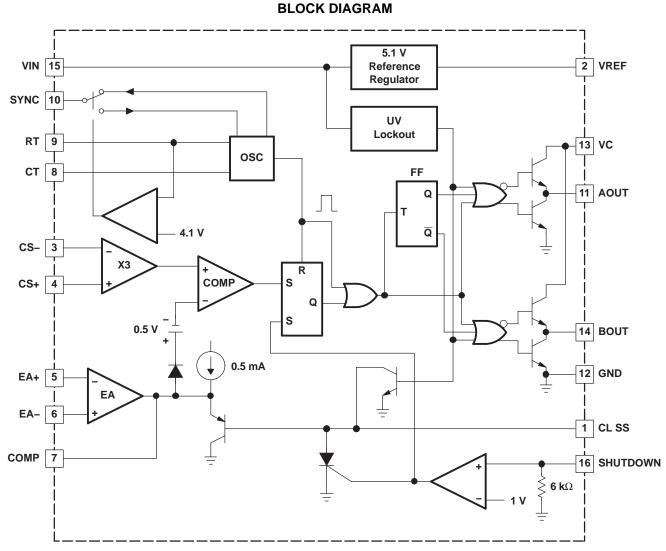
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TEXAS INSTRUMENTS

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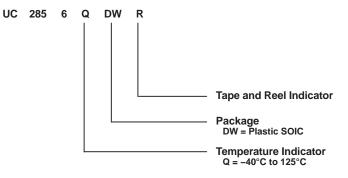


These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



B0010-01

ORDERING INFORMATION



ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)^{(1) (2)}

| | | | UNIT |
|------------------|--------------------------------------|---------------------------------|----------------|
| | Supply voltage | | 40 V |
| | Collector supply voltage | | 40 V |
| | | DC | 0.5 A |
| I _O | Output current (sink or source) | Pulse (0.5 ms) | 2 A |
| | Error amplifier input voltage | | -0.3 V to VIN |
| | Shutdown input voltage | | –0.3 V to 10 V |
| | Current sense input voltage | | –0.3 V to 3 V |
| | SYNC output current | | ±10 mA |
| | Error amplifier output current | | -5 mA |
| | Soft start sink current | | 50 mA |
| | Oscillator charging current | | 5 mA |
| | | T _A = 25°C | 1 W |
| | Power dissipation | $T_{\rm C} = 25^{\circ}{\rm C}$ | 2 W |
| TJ | Operating junction temperature range | | –55°C to 150°C |
| T _{stg} | Storage temperature range | | –65°C to 150°C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Unless otherwise indicated, voltages are reference to ground and currents are positive into and negative out of the specified terminals.

ELECTRICAL CHARACTERISTICS

 $T_A = -40^{\circ}$ C to 125°C, VIN = 15 V, RT = 10 k Ω , CT = 1 nF, and $T_A = T_J$ (unless otherwise stated)⁽¹⁾

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------------|--|------|-----|------|------|
| REFERENCE SECTION | | | | | |
| Output voltage | $I_{O} = 1 \text{ mA}, \qquad T_{J} = 25^{\circ}\text{C}$ | 5.05 | 5.1 | 5.15 | V |
| Line regulation voltage | VIN = 8 V to 40 V | | | 20 | mV |
| Load regulation voltage | $I_{O} = -1$ mA to -10 mA | | | 15 | mV |
| Total output variation | Line, Load, and Temperature | 5 | | 5.2 | V |
| Output noise voltage | $f = 10 \text{ Hz to } 10 \text{ kHz}, 	 T_J = 25^{\circ}\text{C}$ | ; | 50 | | μV |
| Long term stability | 1000 hours, ⁽²⁾ $T_J = 25^{\circ}C$ | ; | 5 | 25 | mV |
| Short circuit current | VREF = 0 V | -25 | -45 | -65 | mA |
| OSCILLATOR SECTION | | | | | |
| | $T_J = 25^{\circ}C$ | 180 | 200 | 220 | kHz |
| Initial accuracy | T _J = Full range | 170 | | 230 | KIIZ |
| Voltage stability | VIN = 8 V to 40 V | | | 2% | |
| Discharge aurrent | $VCT = 2 V, 	 T_J = 25^{\circ}C$ | 7.5 | 8 | 8.8 | mA |
| Discharge current | VCT = 2 V | 6.7 | 8 | 8.8 | ША |
| Sync output high level voltage | $I_{O} = -1 \text{ mA}$ | 2.4 | 3.6 | | V |
| Sync output low level voltage | $I_0 = 1 \text{ mA}$ | | 0.2 | 0.4 | V |
| Sync input high level voltage | CT = 0 V, RT = VREF | 2 | 1.5 | | V |
| Sync input low level voltage | CT = 0 V, RT = VREF | | 1.5 | 0.8 | V |
| Sync input current | CT = 0 V, RT = VREF, V _{SYNC} = 5 V | | 1 | 10 | μA |
| Sync delay to outputs | $CT = 0 V RT = VREF, V_{SYNC} = 0.8 V to$ | 2 V | 50 | 100 | ns |

(1) All voltages are with respect to GND. Currents are positive into, negative out of the specified terminal.

(2) This parameter, although specified over the recommended operating conditions, is not 100% tested in production.

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ISTRUMENTS

EXAS

ELECTRICAL CHARACTERISTICS (continued)

 $T_A = -40^{\circ}$ C to 125°C, VIN = 15 V, RT = 10 k Ω , CT = 1 nF, and $T_A = T_J$ (unless otherwise stated)⁽¹⁾

| PARAMETER | TEST CON | MIN | TYP | MAX | UNIT | |
|--|--------------------------------------|-------------------------------|------|--------------------|-------|-----|
| ERROR AMPLIFIER SECTION | | | | | · | |
| Input offset voltage | V _{CM} = 2 V | | | | 5 | mV |
| Input bias current | | | | | -1 | μA |
| Input offset current | | | | | 500 | nA |
| Common mode range | VIN = 8 V to 40 V | | 0 | | VIN–2 | V |
| Open loop gain | $V_0 = 1.2 V \text{ to } 3 V$ | | 80 | 100 | | dB |
| Unity gain bandwidth | $T_J = 25^{\circ}C$ | | 1 | 1.5 | | MHz |
| CMRR | $V_{CM} = 0 V$ to 38 V, | VIN = 40 V | 75 | 100 | | dB |
| PSRR | VIN = 8 V to 40 V | | 80 | 100 | | dB |
| Output sink current | V _{ID} = -15 mV | V _{COMP} = 1.2 V | 5 | 10 | | mA |
| Output source current | V _{ID} = 15 mV | V _{COMP} = 2.5 V | -0.4 | -0.5 | | mA |
| High-level output voltage | V _{ID} = 50 mV, | R_L (COMP) = 15 k Ω | 4.3 | 4.6 | 4.9 | V |
| Low-level output voltage | $V_{ID} = -50 \text{ mV},$ | R_L (COMP) = 15 k Ω | | 0.7 | 1 | V |
| CURRENT SENSE AMPLIFIER SECTION | | | | | | |
| Amplifier gain | V _{CS-} = 0 V, | CL SS Open ^{(3) (4)} | 2.5 | 2.75 | 3 | V/V |
| Maximum differential input signal (V _{CS+} – V _{CS-}) | CL SS Open 3, | R_L (COMP) = 15 k Ω | 1.1 | 1.2 | | V |
| Input offset voltage | V _{CL SS} = 0.5 V | COMP open ⁽³⁾ | | 5 | 35 | mV |
| CMRR | $V_{CM} = 0 V \text{ to } 3 V$ | | 60 | | | dB |
| PSRR | VIN = 8 V to 40 V | | 60 | | | dB |
| Input bias current | V _{CL SS} = 0.5 V, | COMP open ⁽³⁾ | | | -1 | μA |
| Input offset current | $V_{CL SS} = 0.5 V,$ | COMP open ⁽³⁾ | | | 1 | mA |
| Input common mode range | | | 0 | | 3 | V |
| Delay to outputs | $V_{EA+} = VREF, EA- = 0 V, C$ | S+ – CS– = 0 V to 1.5 V | | 120 | 250 | ns |
| CURRENT LIMIT ADJUST SECTION | | · | | | | |
| Current limit offset | $V_{CS-} = 0 V, V_{CS+} = 0 V,$ | COMP Open ⁽³⁾ | 0.4 | 0.5 | 0.6 | V |
| Input bias current | V _{EA+} = VREF, | $V_{EA-} = 0 V$ | | -10 | -30 | μA |
| SHUTDOWN TERMINAL SECTION | • | • | | | | |
| Threshold voltage | | | 0.95 | 1.00 | 1.05 | V |
| Input voltage range | | | 0 | | 5 | V |
| Minimum latching current (I _{CL SS}) | | | (5)3 | 1.5 | | mA |
| Maximum non-latching current (I _{CL SS}) | | | | ⁽⁶⁾ 1.5 | 0.8 | mA |
| Delay to outputs | V _{SHUTDOWN} = 0 V to 1.3 V | | | 65 | 110 | ns |
| OUTPUT SECTION | | | | | | |
| Collector-emitter voltage | | | 40 | | | V |
| Off-state bias current | VC = 40 V | | | | 250 | μA |
| | I _{OUT} = 20 mA | | | 0.1 | 0.5 | |
| Output low level voltage | I _{OUT} = 200 mA | | | 0.5 | 2.6 | V |
| | I _{OUT} = -20 mA | | 12.5 | 13.2 | | |
| Output high level voltage | I _{OUT} = -200 mA | | 12 | 13.1 | | V |
| Rise time | C1 = 1 nF | | | 40 | 80 | ns |
| Fall time | C1 = 1 nF | | | 40 | 80 | ns |
| UVLO low saturation | VIN = 0 V, | I _{OUT} = 20 mA | | 0.8 | 1.5 | V |

(3) Parameter measured at trip point of latch with VEA+ = VREF, VEA- = 0 V.

$$G = \frac{\Delta V_{COMP}}{\Delta V_{CS}}; \Delta V_{CS} - = 0 V 1 V.$$

(4) Amplifier gain defined as: ^{ΔV}CS+
(5) Current into CL SS assured to latch circuit into shutdown state.

(6) Current into CL SS assured not to latch circuit into shutdown state.



ELECTRICAL CHARACTERISTICS (continued)

 $T_A = -40^{\circ}$ C to 125°C, VIN = 15 V, RT = 10 k Ω , CT = 1 nF, and $T_A = T_J$ (unless otherwise stated)⁽¹⁾

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------------------|-----------------|-----|-----|-----|------|
| PWM SECTION | | | | | |
| Maximum duty cycle | | 45% | 47% | 50% | |
| Minimum duty cycle | | | | 0% | |
| UNDERVOLTAGE LOCKOUT SECTION | | L | | | |
| Startup threshold | | | 7.7 | 8 | |
| Threshold hysterisis | | | 0.7 | | |
| TOTAL STANDBY CURRENT | • | | | | |
| Supply current | | | 18 | 23 | mA |

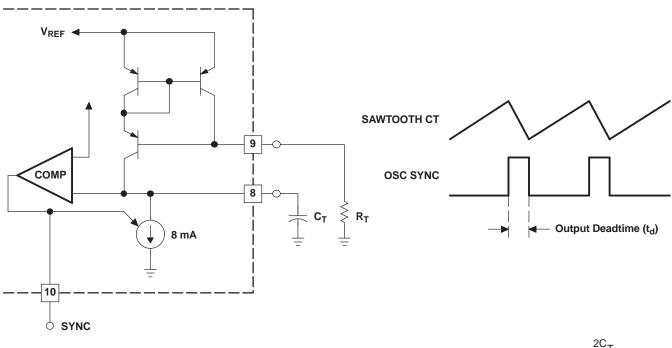
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NOTE: Output deadtime is determined by the size of the external capacitor, C_T , according to the formula: $Td = \frac{2C_T}{8 \text{ mA} - \frac{3.6}{R_T}}$ For large values of R_T : $Td = 250 \text{ C}_T$ Oscillator frequency is approximated by the formula: $f_T = \frac{2}{R_T \times C_T}$

S0019-01



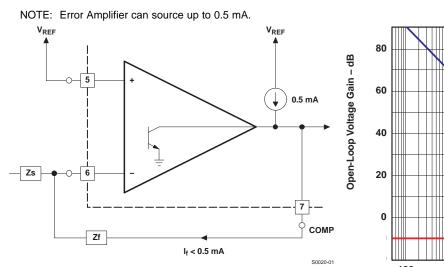


Figure 2. Error Amplifier Output Configuration

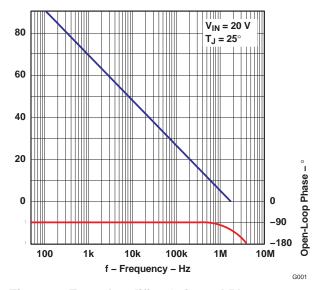


Figure 3. Error Amplifier Gain and Phase vs Frequency



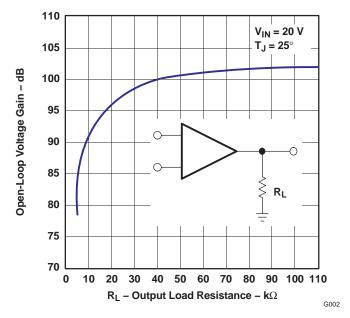
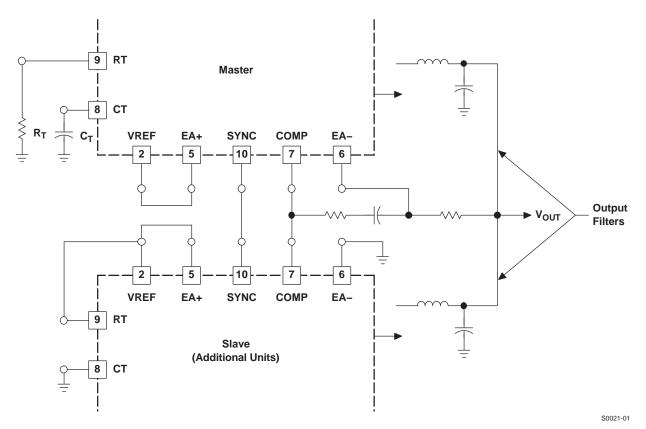


Figure 4. Error Amplifier Open-Loop DC Gain vs Load Resistance



NOTE: Slaving allows parallel operation of two or more units with equal current sharing.

Figure 5. Parallel Operation



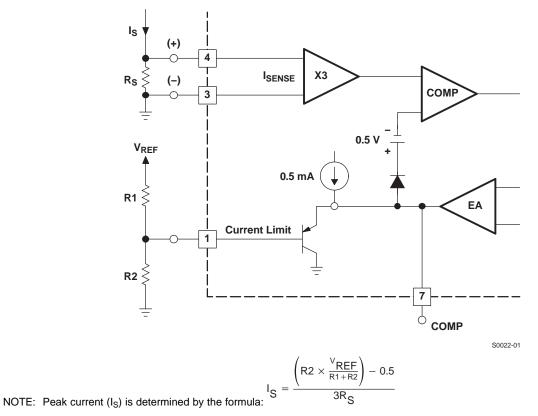
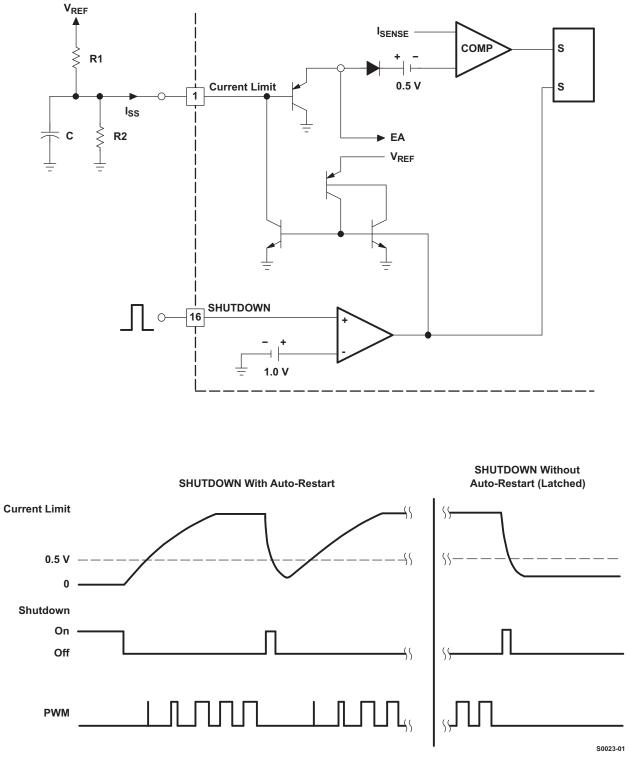


Figure 6. Pulse by Pulse Current Limiting







NOTE: If V_{REF} / R1 < 0.8 mA, the shutdown latch commutates when I_{SS} = 0.8 mA and a restart cycle will be initiated. If V_{REF} / R1 > 3 mA, the device will latch off until power is recycled.

Figure 7. Shutdown



REVISION HISTORY

| Cł | nanges from Original (November 2004) to Revision A | Page |
|----|--|------|
| • | Changed the polarity of the comparator connected to pin 16 in Figure 7 | 9 |



6-Feb-2020

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package | Pins | Package | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|---------|----------------------------|------------------|--------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | (6) | (3) | | (4/5) | |
| UC2856QDWR | ACTIVE | SOIC | DW | 16 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | UC2856Q | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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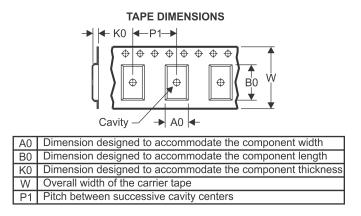
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | |
|-----------------------------|--|
|-----------------------------|--|

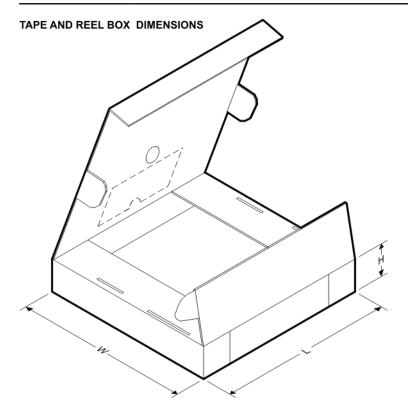
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| UC2856QDWR | SOIC | DW | 16 | 2000 | 330.0 | 16.4 | 10.75 | 10.7 | 2.7 | 12.0 | 16.0 | Q1 |

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

2-Nov-2013



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| UC2856QDWR | SOIC | DW | 16 | 2000 | 367.0 | 367.0 | 38.0 |

DW 16

GENERIC PACKAGE VIEW

SOIC - 2.65 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT

7.5 x 10.3, 1.27 mm pitch

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





DW0016A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.
- 5. Reference JEDEC registration MS-013.



DW0016A

EXAMPLE BOARD LAYOUT

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DW0016A

EXAMPLE STENCIL DESIGN

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



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